

WBC3526DB37CR0

Bottom port digital silicon Microphone

Descriptions

WBC3526DB37CR0is a Silicon Microphone with digital output and bottom inlet for sound input. It consists of a MEMS sensor and an encoder IC. It converts sensor analog output signal into 1-bit digital PDM data. The digital output format eliminates AC coupling capacitor, reduces RF noise coupling and eases PCB layout requirement.

WBC3526DB37CR0 is a cost-effective alternative to traditional electret condenser microphone (ECM). Provided on tap-and-reel, it is ideally suited for high volume applications. And it can be processed directly to customer's PCB using standard automatic pick-and-place equipment and surface mounted via standard solder reflow equipment.

WBC3526DB37CR0 can be used to implement the array microphones. Speech quality can be significantly improved by combining two microphones.

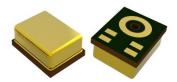
The WBC3526DB37CR0is manufactured in a compact 3.50mm*2.65mm*0.98mm, 5-pin package.

Features

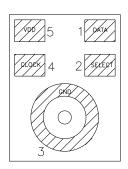
- PDM Output
- High SNR
- Multiple performance modes
- Ultra-Stable Performance
- Standard SMD Reflow
- RoHS/Halogen free compliant
- Omnidirectional

Applications

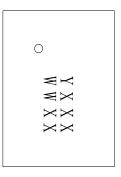
- Smart phones
- Smart speakers
- Portable communication device
- Notebook and desktop
- Digital still cameras
- Smart home electronics



Product appearance



Pin configuration (Bottom view)



Marking (Top view)

Y = Year code WW = Week code X X = Data code

Order information

Device	Package(mm)	Shipping
WBC3526DB37CR 0-	3.50*2.65*0.98	5000/Reel&Tape

5/TR



Absolute Maximum Ratings

Parameter	Maximum Ratings	Unit
Supply voltage	3.6	V
Voltage on any pin	3.6	V
Operation temperature range	-40~85	$^{\circ}$ C
Storage temperature range	-40~100	$^{\circ}$ C

Stresses at the maximum ratings shown in Table 1 may cause permanent damage to the device. These are stress ratings only at which the device may not function when an operation at these or any other condition beyond those specified under "Electro-Acoustic Specifications".



Acoustic & Electrical Specifications

Normal Mode Electrical Specifications

Test condition: $+25\pm2\Box$, $60\%\sim70\%$ RH, $86\sim106$ Kpa, F_{CLK}=2.4MHz,V_{DD}=1.8V, no load, unless otherwise noted.

Symbol	Description		Тур.	Max.	Units
FCLK	Clock Frequency	1.2	2.4	3.3	MHz
IDD	Supply Current1		970	1100	uA
S	Sensitivity,94dB SPL@1KHz		-37	-36	dBFS 2
ΔS	Sensitivity drop		<0.5		dBFS
SNR	20-20KHz Bandwidth, A-weighted		65.5		dB(A)
THD	94dB SPL@1KHz		0.12	0.5	%
וחט	122dB SPL@1KHz		1		%
AOP 10%THD@1KHz			131		dBSP L
PSR	Measured with 217Hz,100mVpp square wave		-93	-80	dBFS

Low Power Mode Electrical Specifications

Test condition: $+25\pm2^{\circ}$ C, $60\%\sim70\%$ RH, $86\sim106$ Kpa, FCLK=768KHz, VDD=1.8V, no load, unless otherwise noted.

Symbol	Description		Тур.	Max	Units
FCLK	Clock Frequency	450	768	850	KHz
IDD	Supply Current		280	350	uA
S	Sensitivity,94dB SPL@1KHz	-22	-21	-20	dBFS
ΔS Sensitivity drop		<0.5			dBFS
SNR	20Hz~8KHz Bandwidth, A-weighted		65		dB(A)
THD	94dB SPL@1KHz		0.13	0.5	%
טחו	110dB SPL@1KHz		1		%
AOP	AOP 10%THD@1KHz		116		dBSPL
PSR	Measured with 217Hz,100mVpp square wave		-80	-70	dBFS

- Note 1:The current consumption depends on the applied clock frequency and the load on the DATA output
- Note 2:dBFS=20*logA/B, where A is the level of signal, and B is the level that corresponds to full-scale level
- Note 3:Relativetothermslevelofasinewavewithpositiveamplitudeequalto100%1sdensityand Negativeamplitudeequalto0%1sdensity
- Note 4: Frequency response, sensitivity and current consumption are tested by 100% on product line.

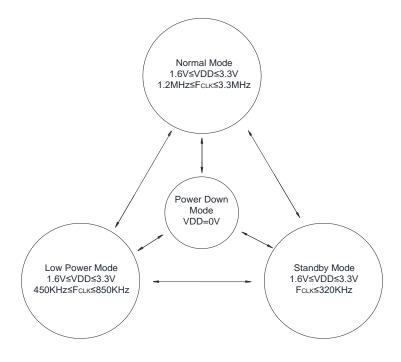


Electrical Specifications

Test condition: +25±2 $^{\circ}$ C, 60% \sim 70% RH, 86~106Kpa, no load, unless otherwise noted.

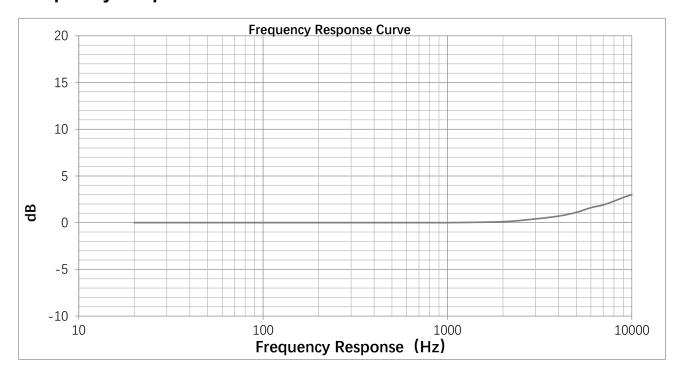
Symbol	Description		Min.	Тур.	Max.	Units
VDD	Supply \	Voltage	1.6	1.8	3.3	V
		Standby Mode			320	KHz
FCLK	Clock Frequency	Low Power Mode	450	768	850	KHz
		Normal Mode	1.2	2.4	3.3	MHz
Data Format				1/2 Cyc	le PDM	
Directivity				Omni-di	rectiona	
Polarity	Increasing so	und pressure	Increasing density of 1's			f 1's
ISC	Short circuit current, Grounded DATA		1		20	mΑ
CLOAD	Load capacitance				200	pF
Reset time	Time to start up in any mode after VDD has been off for more than10ms, while CLOCK remained on				20	ms
Start-up time	Start-up into normal mode or LP mode				20	ms
Mode-switch time	Mode-switch Normal mode to LP mode or LP mode to Normal mode			20		ms

Microphone State Diagram

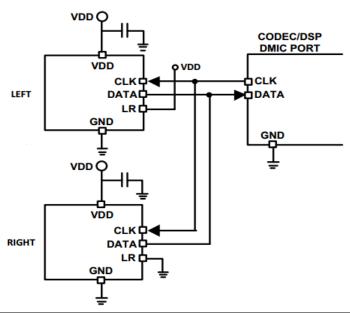




Frequency Response Curve



Application Information



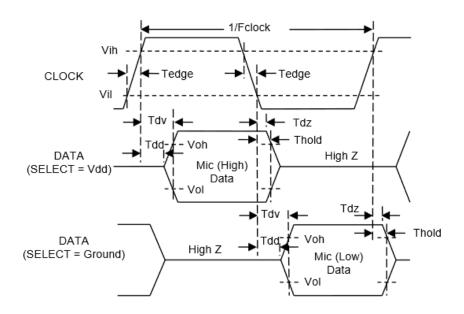
Microphone	SELECT	Asserts DATA On	Latch DATA On
Mic (High)	V_{DD}	Rising Clock Edge	Falling Clock Edge
Mic (Low)	GND	Falling Clock Edge	Rising Clock Edge

Note:

- All GND pins must be connected to ground.
- Capacitors near the microphone should not contain Class 2 dielectrics.



Clock Timing Diagram

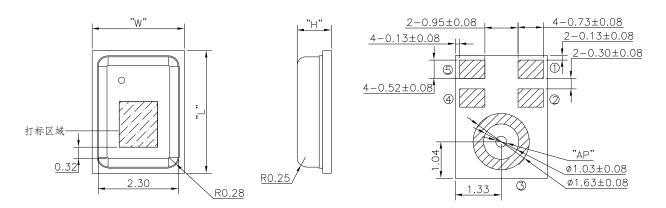


Timing Characteristics

Parameter	Symbol	Min.	Тур.	Max.	Unit	Note
Clock duty cycle		45		55	%	
Operation Voltage	V _{DD}	1.6		3.3	V	
Input Logic Low Level	VIL	-0.3		0.28×V _{DD}	V	
Input Logic High Level	Vih	0.65×V _{DD}		V _{DD} +0.3	V	
Hysteresis width	V _{hys}	0.08			V	
Output Logic Low Level	Vol			0.3×V _{DD}	V	
Output Logic High Level	Vон	0.7×V _{DD}			V	
Clock rise time	tcr			13	ns	
Clock fall time	tcF			13	ns	
Delay time for DATA driven	t _{DD}	28			ns	
Delay time for data valid	t _{DV}			100	ns	
Delay time for data high Z	t _{Hz}	14		26	ns	



Mechanical Specifications



Item	Dimension	Tolerance
Length(L)	3.50	±0.10
Width(W)	2.65	±0.10
Height(H)	0.98	±0.10
Acoustic Port (AP)	Ø0.325	±0.05

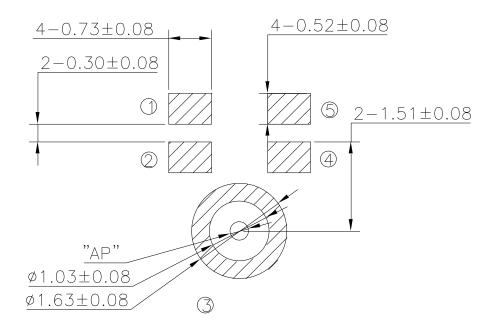
Pin#	Pin Name Description		
1	DATA PDM Output		
2	SELECT	Lo/Hi (L/R) Select	
2 SELECT	SELECT	This pin is internally pulled low but should not be left floating.	
3	GND	GND	
4	CLOCK Clock input		
5	VDD	Power Supply	

Notes:

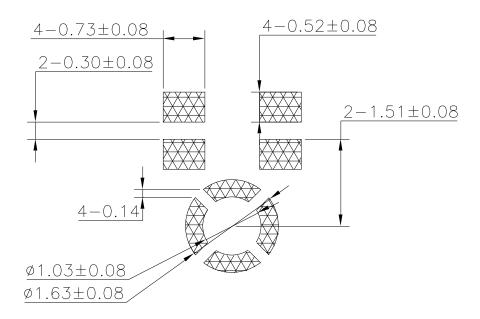
- Dimensions are in millimeters unless otherwise specified.
- Tolerance is ±0.10mm unless otherwise specified.
- Pick Area only extends to 0.25 mm of any edge or hole unless otherwise specified.
- Suggestion to use the same date code microphone in one array microphone module.



Example Land Pattern



Example Solder Stencil Pattern

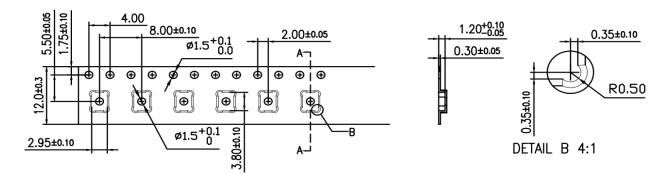


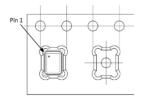
Notes: Dimensions are in millimeters unless otherwise specified.

Further optimizations based on application should be performed.



Packaging & Marking Detail





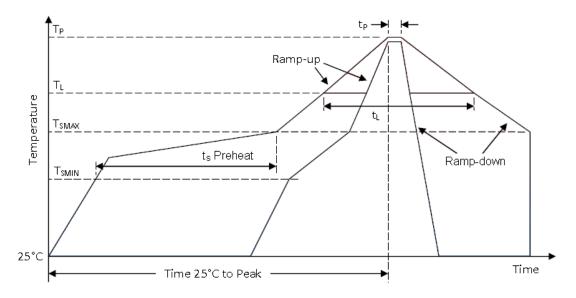
Model Number	Reel Diameter	Quantity Per Reel
WBC3526DB37CR0	13"	5,500

Notes:

- Dimensions are in millimeters unless otherwise specified.
- Vacuum pickup only in the pick area indicated in Mechanical Specifications.
- Tape & reel per EIA-481.
- Labels applied directly to reel and external package.



Referenced Reflow Profile



Profile Feature	Pb-Free
Average Ramp-up rate (Tsmax to Tp)	3°C/second max.
Preheat • Temperature Min (Tsmin) • Temperature Max (Tsmax) • Time (Tsmin to Tsmax) (ts)	150°C 200°C 60-180 seconds
Time maintained above: • Temperature (TL) • Time (tL)	217°C 60-150 seconds
Peak Temperature (T _P)	260°C
Time within 5°C of actual Peak Temperature (t₁)	20-40 seconds
Ramp-down rate (TP to TSMAX)	6°C/second max
Time 25°C to Peak Temperature	8 minutes max

Note:

All temperatures refer to topside of the package, measured on the package body surface.

Additional Notes

- (A) Maximum of 3 reflow cycles is recommended.
- (B) In order to minimize device damage:
 - Do not board wash or clean after the reflow process.
 - Do not brush board with or without solvents after the reflow process.
 - Do not directly expose to ultrasonic processing, welding, or cleaning.
 - Do not insert any object in port hole of device at any time.
 - Do not apply over 30 psi of air pressure into the port hole.
 - Do not pull a vacuum over port hole of the microphone.
 - Do not apply a vacuum when repacking into sealed bags at a rate faster than 0.5 atm/sec.



Materials Statement

Meets the requirements of the European RoHS and Halogen-Free.

Reliability Specifications

Test	Description
Thermal Shock	100 cycles air-to-air thermal shock from -40°C to +125°C with 15 minute soaks. (IEC 68-2-4)
High Temperature Storage	1000 hours at +105°C environment. (IEC 68-2-2 Test Ba)
Low Temperature Storage	1000 hours at -40°C environment. (IEC 68-2-2 Test Aa)
High Temperature Bias	1000 hours at +105°C under bias. (IEC 68-2-2 Test Ba)
Low Temperature Bias	1000 hours at -40°C under bias. (IEC 68-2-2 Test Aa)
Temperature / Humidity Bias	1000 hours at +85°C /85% R.H. under bias. (JESD22-A101A-B)
Vibration	4 cycles of 20 to 2,000 Hz sinusoidal sweep with 20g peak acceleration lasting 12 minutes in X, Y, and Z directions. (Mil-Std-883E, method 2007.2 A)
ESD-HBM	3 discharges of ±3.5kV direct contact to I/O pins. (ESD STM5.2)
ESD-LID/GND	3 discharges of ±8 kV direct contact to lid while unit is grounded. (IEC 61000-4-2)
ESD-MM	3 discharges of ±200V direct contact to I/O pins. (ESD STM5.2)
Reflow	5 reflow cycles with peak temperature of +260°C.
Mechanical Shock	3 pulses of 10000g in the X, Y, and Z direction. (IEC 68-2-27, Test Ea)
Drop Test	To be no interference in operation after dropped to marble or 1.0cm steel plate 18 times from 1.5 meter height.

Note:

After reliability tests are performed, the sensitivity of the microphones shall not deviate more than 3 dB from its initial value. (The measurement to be done after 2 hours of conditioning at 20±2 °C, R.H 60% \sim 70%)